Pre-Release Information

P-Channel Enhancement-Mode Vertical DMOS FETs

Ordering Information

BV_{DSS} / BV_{DGS}	$R_{DS(ON)}$ (max)	$V_{GS(th)}$ (max)	$I_{D(ON)}$ (min)	Order Number / Package
				TO-243AA*
-240V	8.0Ω	-2.4V	-800mA	TP2424N8

* Same as SOT-89. Product supplied on 2000 piece carrier tape reels.

Features

- ☐ Low threshold
- ☐ High input impedance
- ☐ Low input capacitance
- ☐ Fast switching speeds
- ☐ Free from secondary breakdown
- ☐ Low input and output leakage
- ☐ Complementary N- and P-channel devices

Applications

- ☐ Logic level interfaces – ideal for TTL and CMOS
- ☐ Solid state relays
- ☐ Linear Amplifiers
- ☐ Power Management
- ☐ Analog switches
- ☐ Telecom switches

Absolute Maximum Ratings

Drain-to-Source Voltage	BV_{DSS}
Drain-to-Gate Voltage	BV_{DGS}
Gate-to-Source Voltage	± 20V
Operating and Storage Temperature	-55°C to +150°C
Soldering Temperature*	300°C

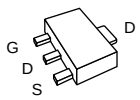
* Distance of 1.6 mm from case for 10 seconds.

Low Threshold DMOS Technology

These low threshold enhancement-mode (normally-off) power transistors utilize a vertical DMOS structure and Supertex's well-proven silicon-gate manufacturing process. This combination produces devices with the power handling capabilities of bipolar transistors and with the high input impedance and positive temperature coefficient inherent in MOS devices. Characteristic of all MOS structures, these devices are free from thermal runaway and thermally induced secondary breakdown.

Supertex's vertical DMOS FETs are ideally suited to a wide range of switching and amplifying applications where very low threshold voltage, high breakdown voltage, high input impedance, low input capacitance, and fast switching speeds are desired.

Package Options



TO-243AA
(SOT-89)

Note: See Package Outline section for dimensions.

Thermal Characteristics

Package	I_D (continuous)*	I_D (pulsed)	Power Dissipation @ T_A = 25°C	θ_{jc} °C/W	θ_{ja} °C/W	I_{DR}*	I_{DRM}
TO-243AA	-316mA	-1.9A	1.6W†	15	78†	-316mA	-1.9A

* I_D (continuous) is limited by max rated T_j.

† Mounted on FR5 board, 25mm x 25mm x 1.57mm. Significant P_D increase possible on ceramic substrate.

Electrical Characteristics (@ 25°C unless otherwise specified)

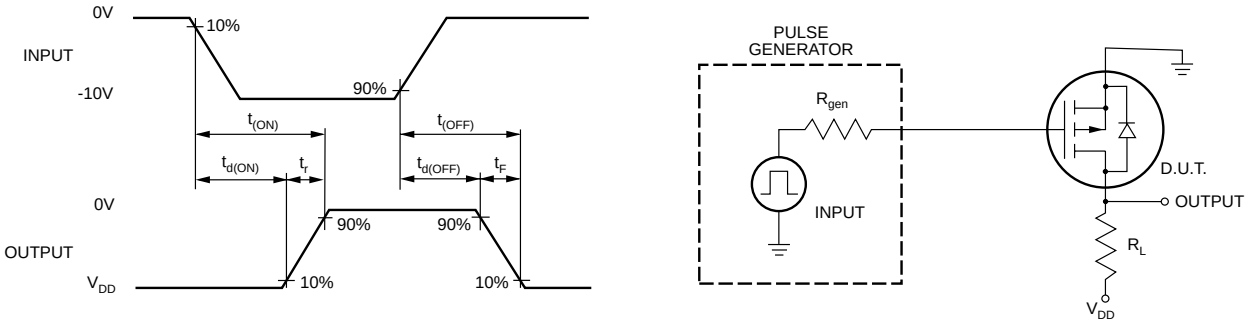
Symbol	Parameter	Min	Typ	Max	Unit	Conditions
BV_{DSS}	Drain-to-Source Breakdown Voltage	-240			V	V_{GS} = 0V, I_D = -250µA
$V_{GS(th)}$	Gate Threshold Voltage	-1.0		-2.4	V	V_{GS} = V_{DS}, I_D= -1.0mA
$\Delta V_{GS(th)}$	Change in $V_{GS(th)}$ with Temperature			4.5	mV/°C	V_{GS} = V_{DS}, I_D= -1.0mA
I_{GSS}	Gate Body Leakage			-100	nA	V_{GS} = ± 20V, V_{DS} = 0V
I_{DSS}	Zero Gate Voltage Drain Current			-10.0	µA	V_{GS} = 0V, V_{DS} = Max Rating
				-1.0	mA	V_{GS} = 0V, V_{DS} = 0.8 Max Rating T_A = 125°C
$I_{D(ON)}$	ON-State Drain Current	-0.3			A	V_{GS} = -4.5V, V_{DS} = -25V
		-0.8				V_{GS} = -10V, V_{DS} = -25V
$R_{DS(ON)}$	Static Drain-to-Source ON-State Resistance			10.0	Ω	V_{GS} = -4.5V, I_D = -150mA
				8.0		V_{GS} = -10V, I_D = -500mA
$\Delta R_{DS(ON)}$	Change in $R_{DS(ON)}$ with Temperature			0.75	%/°C	V_{GS} = -10V, I_D = -500mA
G_{FS}	Forward Transconductance	150			m℧	V_{DS} = -25V, I_D = -200mA
C_{ISS}	Input Capacitance			200	pF	V_{GS} = 0V, V_{DS} = -25V f = 1.0 MHz
C_{OSS}	Common Source Output Capacitance			100		
C_{RSS}	Reverse Transfer Capacitance			40		
$t_{d(ON)}$	Turn-ON Delay Time			20	ns	V_{DD} = -25V, I_D = -250mA, R_{GEN} = 25Ω
t_r	Rise Time			30		
$t_{d(OFF)}$	Turn-OFF Delay Time			35		
t_f	Fall Time			25		
V_{SD}	Diode Forward Voltage Drop			-1.5	V	V_{GS} = 0V, I_{SD} = -500mA
t_{rr}	Reverse Recovery Time		300		ns	V_{GS} = 0V, I_{SD} = -500mA

Notes:

1.All D.C. parameters 100% tested at 25°C unless otherwise stated. (Pulse test: 300µs pulse, 2% duty cycle.)

2.All A.C. parameters sample tested.

Switching Waveforms and Test Circuit



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